

August 2010

LL4148 Small Signal Diode



COLOR BAND MARKING

1ST BAND 2ND BAND

Black Green

Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	100	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
i _f	Recurrent Peak Forward Current	500	mA
I _{FSM}	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 2.0	A A
T _{STG}	Storage Temperature Range	-65 to +200	°C
T _J	Operating Junction Temperature	175	°C

^{*} These ratings are limiting values above which the serviceability of the diode may be impaired.

Notes:

- 1) These ratings are based on a maximum junction temperature of 200degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

Note: Jedec Standard 51-3 method (PCB Board size 76*114*0.6Tmm3)

Electrical Characteristics $T_a = 25^{\circ}C$ unless otherwise noted.

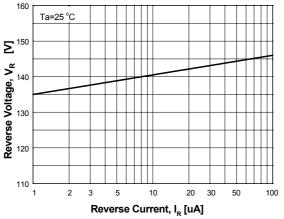
Symbol	Parameter	Conditions	Min.	Max.	Units
V_R	Breakdown Voltage	I _R = 100μA I _R = 5.0μA	100 75		V V
V _F	Forward Voltage	I _F = 10mA		1.0	V
I _R	Reverse Leakage	V _R = 20V V _R = 20V, T _A = 150°C		25 50	nA μA
C _T	Total Capacitance	V _R = 0, f = 1.0MHz		4.0	pF
t _{rr}	Reverse Recovery Time	$I_F = 10\text{mA}, V_R = 6.0\text{V } (60\text{mA}),$ $I_{rr} = 1.0\text{mA}, R_L = 100\Omega$		4.0	ns

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
Color Band Marking	LL4148	SOD80	7"	8mm	2,500

Typical Performance Characteristics

Figure 1. Reverse Voltage vs Reverse Current BV - 1.0 to 100μA



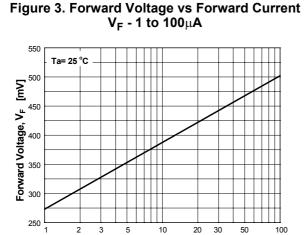


Figure 5. Forward Voltage vs Forward Current V_F - 10 to 800mA

Forward Current, I_F [uA]

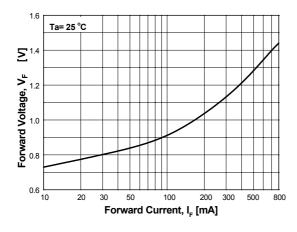


Figure 2. Reverse Voltage vs Reverse Current I_R - 10 to 100V

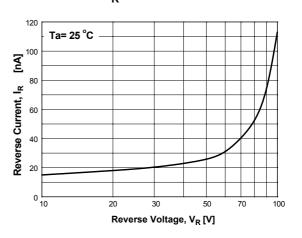


Figure 4. Forward Voltage vs Forward Current V_F - 0.1 to 10mA

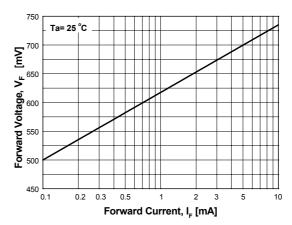
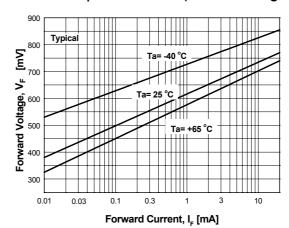


Figure 6. Forward Voltage vs **Ambient Temperature** V_F - 0.01 - 20mA (-40 to +65 Deg C)



Typical Performance Characteristics (Continued)

Figure 7. Total Capacitance

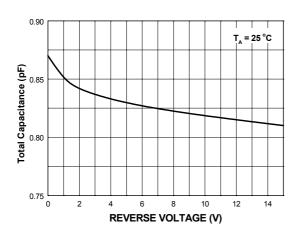


Figure 8. Reverse Recovery Time vs Reverse Recovery Current

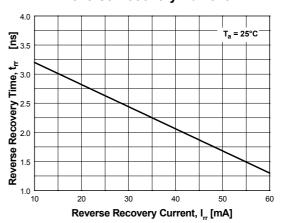


Figure 9. Average Rectified Current $(I_{F(AV)})$ versus Ambient Temperature (T_A)

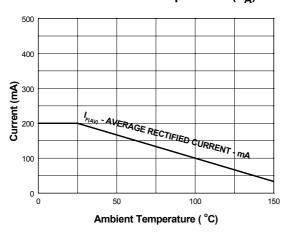
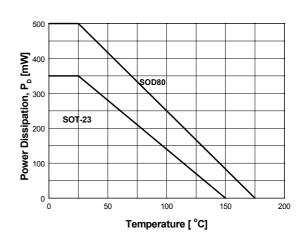
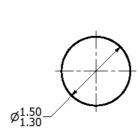


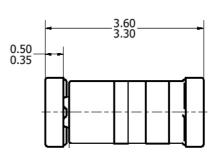
Figure 10. Power Derating Curve



Physical Dimensions

SOD80





NOTE/s:

- 1) THIS PACKAGE CONFORMS TO JEDEC DO-213D, VARIATION AC, DATED 9/1988. 2) ALL DIMENSIONS ARE IN MILLIMETERS.





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Definition of Terms				
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